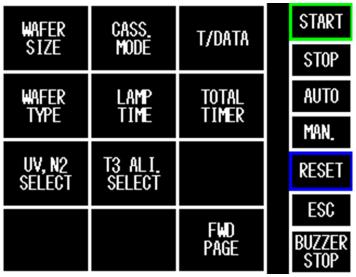
5.3 Setting screens

To enter each setting screen, display the screens shown below. Press [INIT.RESET] key after the setting has been changed.

- [FWD PAGE] key: Pressing the key displays "2nd page of the setting screen".
 - [REV PAGE] key: Pressing the key displays "1st page of the setting screen".

- [AUTO] key: Pressing the key displays MAIN SCREEN.

<1st page of the setting screen>



<2nd page of the setting screen>

5010012			
ALIGNER	3-TIMES Apply	APPLY Down	START
			ST0P
T/1,2 SELECT	T/1,2 T/3 REPEEL		AUTO
SELECT	SELECT	SELECT	MAN_
PAD UP Timer	TABLE Blow		
TIPEK	BLUW	TIPEK	ESC
REV Page	TBL. PAD SELECT	ROB. VAC. SELECT	
			BUZZER STOP

WAFER SIZE <SCREEN FOR WAFER SIZE>



You can select a wafer size for process on the screen.

The selected item lights up green.

Press [INIT.RESET] key after the setting has been changed.

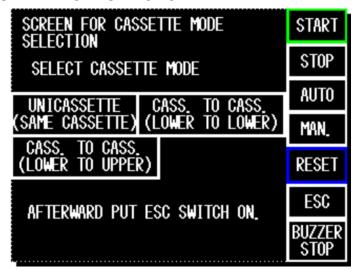
- 5 INCH: Press the key when 5-inch wafers are processed.
- 6 INCH: Press the key when 6-inch wafers are processed.
- 8 INCH: Press the key when 8-inch wafers are processed.

8-inch wafer has 2types (Notch and OF). It requires to set on "SCREEN FOR WAFER

TYPE".

- [ESC] key: Pressing the key displays "1st page of the setting screen".

CASS. MODE <SCREEN FOR CASSEETTE MODE SELECTION>



You can select a cassette mode for process on the screen.

In the case CASS TO CASS mode is selected, place <u>a cassette with wafers on the right table</u>, and an <u>empty cassette on the left table</u>.

The selected item lights up green.

Press [INIT.RESET] key after the setting has been changed.

- UNICASSETTE (SAME CASSETTE): Put the processed wafers into the same cassette.

The cassette placement

- Only the right cassette table.

- Only the left cassette table.

- Both (Process the left cassette first)

- CASS TO CASS (LOWER TO LOWER): The robot arm picks a wafer from the lowest slot of the

right cassette sequentially, and puts the processed wafer into the left cassette from the lowest slot sequentially.

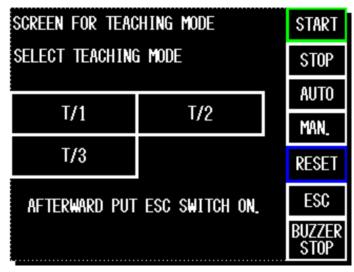
- CASS TO CASS (LOWER TO UPPER): The robot arm picks a wafer from the lowest slot of the

right cassette, and puts the processed wafer into the left

cassette from the highest slot sequentially.

- [ESC] key: Pressing the key displays "1st page of the setting screen".

T/DATA <SCREEN FOR TEACHING MODE>



Teaching data is the wafer handling data with the robot.

You can select the teaching data type for process on the screen.

The selected item lights up green.

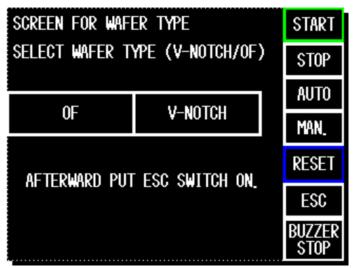
Press [INIT.RESET] key after the setting has been changed.

- T/1: A data from CASS 1-8 is used for the operation. Normally the teaching data for 25-slot cassette is included.
- T/2: A data from CASS 9-16 is used for the operation. Normally the teaching data for 12-slot cassette is included.
- T/3: A data from CASS 17-24 is used for the operation. We prepare the teaching data in according to the requirements from the customer.
- [ESC] key: Pressing the key displays "1st page of the setting screen".
- [AUTO] key: Pressing the key displays MAIN SCREEN.

Parameter	Size of the wafer	Cassette table	Pcs*	Mode
CASS 1	4-inch			
CASS 2	5-inch	Right	- 25	T/1
CASS 3	6-inch			
CASS 4	8-inch			
CASS 5	4-inch	Left		
CASS 6	5-inch			
CASS 7	6-inch			
CASS 8	8-inch			
CASS 9	4-inch			
CASS 10	5-inch	Right	12	T/2
CASS 11	6-inch			
CASS 12	8-inch			
CASS 13	4-inch	Left		
CASS 14	5-inch			
CASS 15	6-inch			
CASS 16	8-inch			
CASS 17	4-inch	Right	12	T/3
CASS 18	5-inch			
CASS 19	6-inch			
CASS 20	8-inch			
CASS 21	4-inch	- Left		
CASS 22	5-inch			
CASS 23	6-inch			
CASS 24	8-inch			

^(*) We prepare the teaching data according to your requirements in the number of slots.

WAFER TYPE <SCREEN FOR WAFER TYPE>



You can select a wafer type (OF or Notch) for process on the screen. The selected item lights up green.

Press [INIT.RESET] key after the setting has been changed.

- OF: Press the key when the OF wafers are processed.

- V-NOTCH: Press the key when the Notch wafers are processed.

- [ESC] key: Pressing the key displays "1st page of the setting screen".

LAMP TIME <SCREEN FOR ALIGNER LAMP TIME>



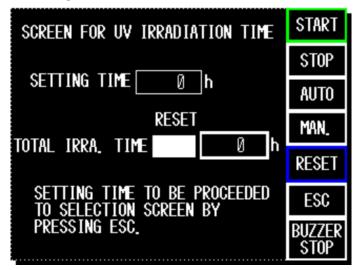
The used hours of the aligner lamp is shown on the screen. After the aligner lamp has been replaced, press [LIGHTING TIME] to reset the used hours.

For the operators:

Do not change the numerical value of "SET LIFE COUNTER".

- [ESC] key: Pressing the key displays "1st page of the setting screen".

TOTAL TIMER <SCREEN FOR UV IRRADIATION TIME>



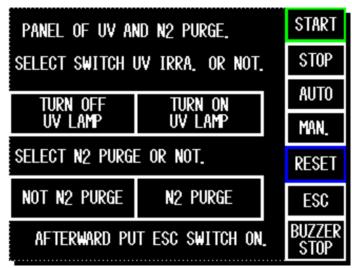
The used hours of the aligner lamp is shown on the screen. After the aligner lamp has been replaced, press [LIGHTING TIME] to reset the used hours.

For the operators:

Do not change the numerical value of "SET LIFE COUNTER".

- [ESC] key: Pressing the key displays "1st page of the setting screen".

UV, N2 SELECT <PANEL OF UV AND N2 PURGE>



You can select the Use / No use of the UV irradiation function for process on the screen. Also, you can select Use / No use of the N_2 purge to the UV chamber when UV irradiation is in use. N_2 is replaced to N_2 to reduce the concentration of N_2 in UV chamber when UV irradiates. The selected item lights up green.

Press [INIT.RESET] key after the setting has been changed.

- TURN OFF UV LAMP: Press the key when the UV lamp is not in use.

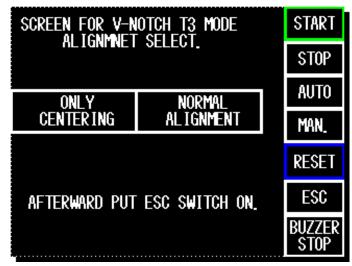
- TURN ON UV LAMP: Press the key when the UV irradiation function is in use.

- NOT N2 PURGE: Press the key when N2 purge function is not in use during UV irradiating.

- N2 PURGE: Press the key when N₂ purge is in use during UV irradiating.

- [ESC] key: Pressing the key displays "1st page of the setting screen".

T/3 ALI. SELECT <SCREEN FOR T3 MODE ALIGNMENT SELECT>



You can select the Use / No use of the V-notch detect function for T3 mode on the screen. The selected item lights up green.

Press [INIT.RESET] key after the setting has been changed.

- ONLY CENTERING: Aligns the wafer without detecting V-notch angle.

- NORMAL ALIGNMENT: Aligns the wafer to the V-notch angle.

- [ESC] key: Pressing the key displays "1st page of the setting screen".